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November 2013

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FQB19N20C — N-Channel QFET® MOSFET

FQB19N20C N-Channel QFET[®] MOSFET 200 V, 19 A, 170 mΩ

Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 19.0 A, 200 V, $R_{DS(on)}$ = 170 m Ω (Max.) @ V_{GS} = 10 V, I_D = 9.5 A
- Low Gate Charge (Typ. 40.5 pr
- Low C_{rss} (Typ. 85 pF)
- 100% Avalanche Tesi
- RoHS Complia.

Absolute Max' tine . Tc = 20°C unless otherwise no.ed

Symbol	Parsmeier	FQB19N20CTM	Unit
V _{DSS}	Drain-Soul ge	200	V
ID	ent - Continuous (T _C = 25°C)	19.0	Α
	- Continucus (T _C = 1೦೦°೧)	12.1	A
I _{DM}	Jrain Current - Pulsed (Note 1)	76.0	Α
	Gate Scurce voltage	± 30	V
E AS	Single Pt ise a Avalanche Energy (Note 2)	433	mJ
	Avalanche Currer (Note 1)	19.0	А
E _{MR}	Repetitive Avalanche Energy (Note 1)	13.9	mJ
dv/dt	Peak Lin le Recovery dv/dt (Note 3)	5.5	V/ns
PD	Power Dissipation $(T_A = 25^{\circ}C)^*$	3.13	W
	Power Dissipation $(T_C = 25^{\circ}C)$	139	W
	- Derate above 25°C	1.11	W/°C
$T_{J,}T_{STG}$	Operating and Storage Temperature Range	-55 to +150	°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds	300	°C

Thermal Characteristics

Symbol	Parameter	FQB19N20CTM	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max. 0.9		
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	62.5	°C/W
	Thermal Resistance, Junction to Ambient (*1 in ² Pad of 2-oz Copper), Max.	40	

Device N	Device Marking Device		Package Reel Size		Ta	ape Width	ו Qu	Quantity	
FQB19	FQB19N20C FQB19N20CTM		D ² -PAK	330 mm	24 mm		800	800 units	
Electric	al Chai	racteristics T _c = 25°C un	less otherwise noted.						
Symbol		Parameter	Condition	ns	Min	Тур	Мах	Unit	
Off Charac	teristics								
BV _{DSS}	Drain-Sou	urce Breakdown Voltage	V_{GS} = 0 V, I _D = 250 µA		200			V	
ΔΒV _{DSS} / ΔΤ _J	Breakdown Voltage Temperature Coefficient		$I_D = 250 \ \mu$ A, Referenced to 25°C			0.24		V/ºC	
I _{DSS}	Zero Gate Voltage Drain Current $V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $V_{DS} = 160 \text{ V}, \text{ T}_{C} = 125^{\circ}$) V			10	μA		
			V _{DS} = 160 V, T _C = 12	25°C			100	μA	
I _{GSSF}	Gate-Bod	y Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0	V			1,	nA	
I _{GSSR}	Gate-Bod	y Leakage Current, Reverse	V_{GS} = -30 V, V_{DS} = 0	V			-10	nA	
On Charac	teristics		•					1	
V _{GS(th)}	Gate Thre	eshold Voltage	$V_{DS} = V_{GS}, I_D = 250$	μA	2.		4.8	V	
R _{DS(on)}	Static Drain-Source $V_{GS} = 10 \text{ V}, I_D = 9.5$			-	0 14	0.17	Ω		
9 _{FS}	Forward Transconductance V _{DS} = 40 V, I _D					10.8		S	
Dynamic C	haracteris	tics) O			1	
C _{iss}	Input Cap	acitance	DS 7.5 V, V, = 6 V,			670	1080	٦¢	
C _{oss}	Output Ca	apacitance				195	255	pF	
C _{rss}	Reverse ⁻	se Transfer Capacitanc		Ō.	-25	110	pF		
Switching	Characteri	stics		77					
t _{d(on)}	Turn-On Delay Tim		V _{DD} = 170 V, I _D = 190 A		10	40	ns		
t _r	Turn-On F	R [;] ie	$r_{G} = 25 \Omega$			150	310	ns	
t _{d(off)}	Turn-Off	elay Time	L'UN	~~``		135	280	ns	
t _f		'Time	Kr 20	(Note 4)		115	240	ns	
Qg	Tot	Charge	V _{DS} = 160 / i _D = 19.	.0 A		40.5	53	nC	
0~	Gate-Sr	.ce Char્ા	V _{GS} = iQ V	ľ		6.0		nC	
Q _{ga}	Gate-Drai	in Charge	1/2	(Note 4)		22.5		nC	
	ve Dicde (Characteristics and Maximu	m Ratings						
	יעיר יאמא'	Continuous Drain-Source Die	ode Forward Current				19.0	Α	
I _{SM}	Maximun Pulsed Drain-Source Diode Fo		Forward Current				76.0	Α	
V _{SL}	Drain-Sou	urce Diocle Forward Voltage	V _{GS} = 0 V, I _S = 19.0 A				1.5	V	
t _{rr}	Reverse I	Racovery Time	V _{GS} = 0 V, I _S = 19.0 A			208		ns	
Q _{rr}			dl _F /dt =100 A/μs			1.63	/	μC	

FQB19N20C — N-Channel QFET® MOSFET

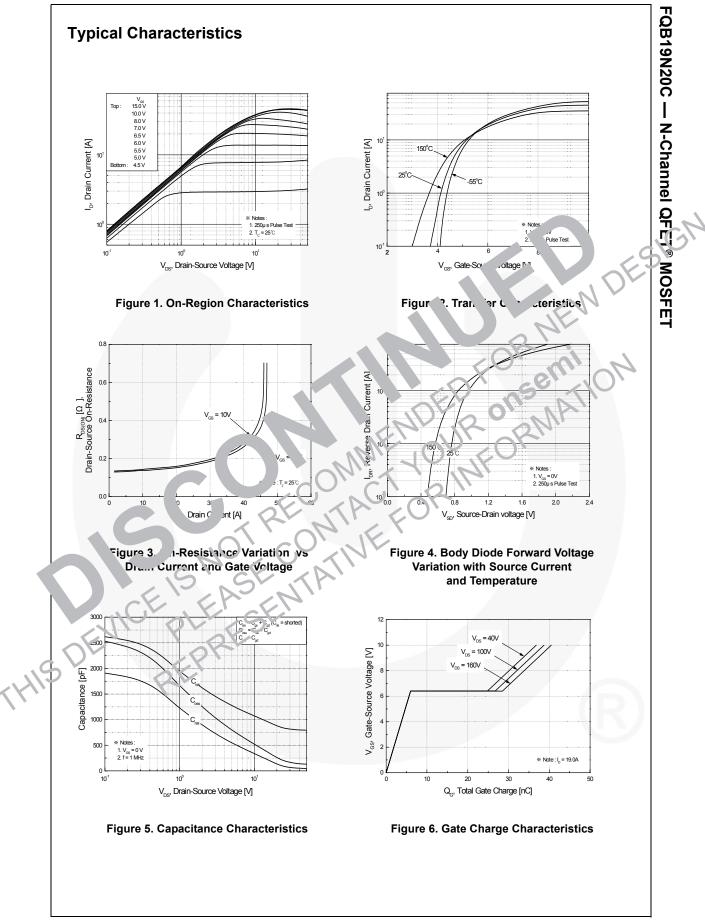
Notes:

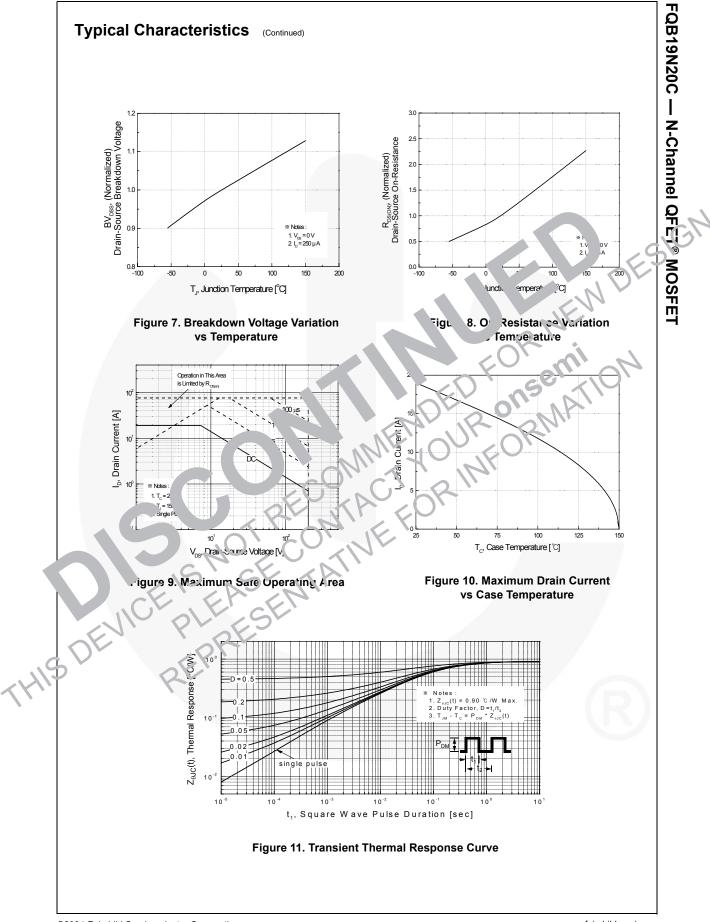
1. Repetitive rating: pulse-width limited by maximum junction temperature.

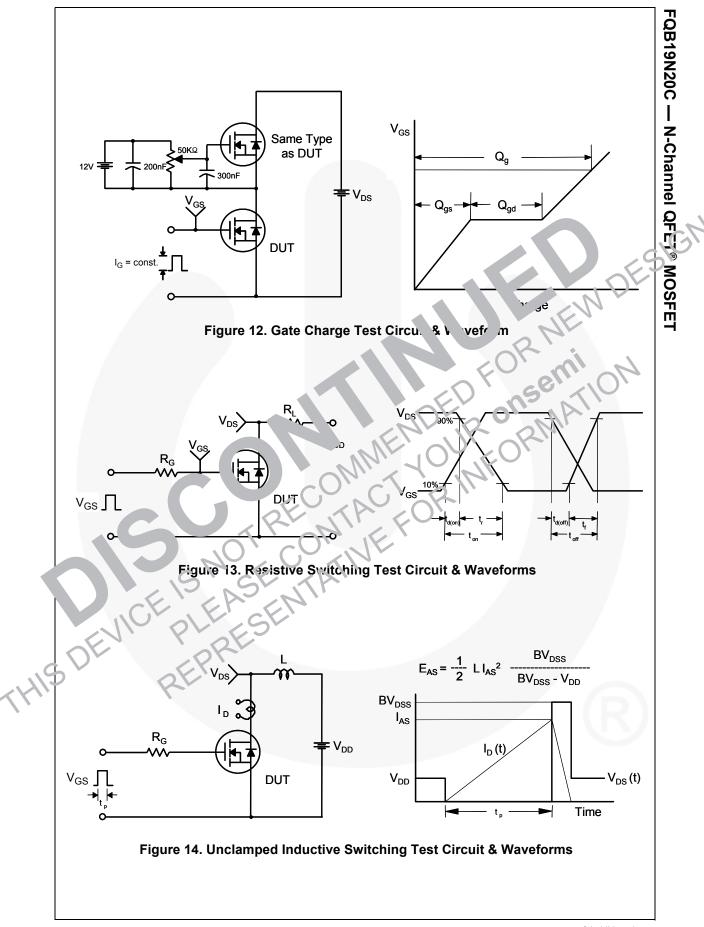
2. L = 1.8 mH, I_{AS} = 19.0 A, V_{DD} = 50 V, R_G = 25 $\Omega,$ starting T_J = 25°C.

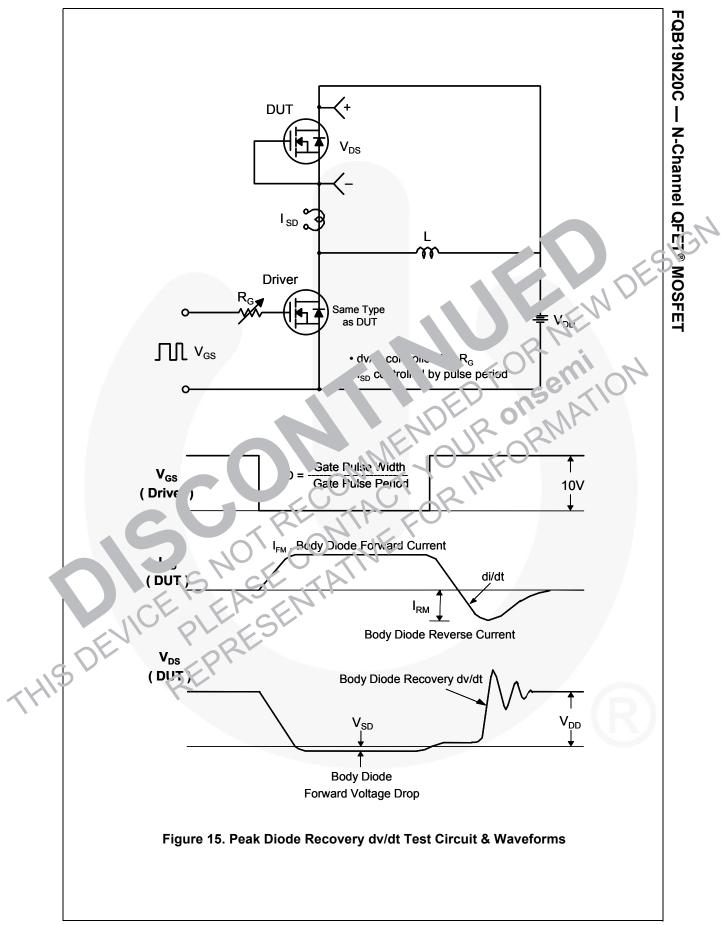
3. I_{SD} \leq 19.0 A, di/dt \leq 300 A/µs, V_{DD} \leq BV_{DSS,} starting ~ T_J = 25°C.

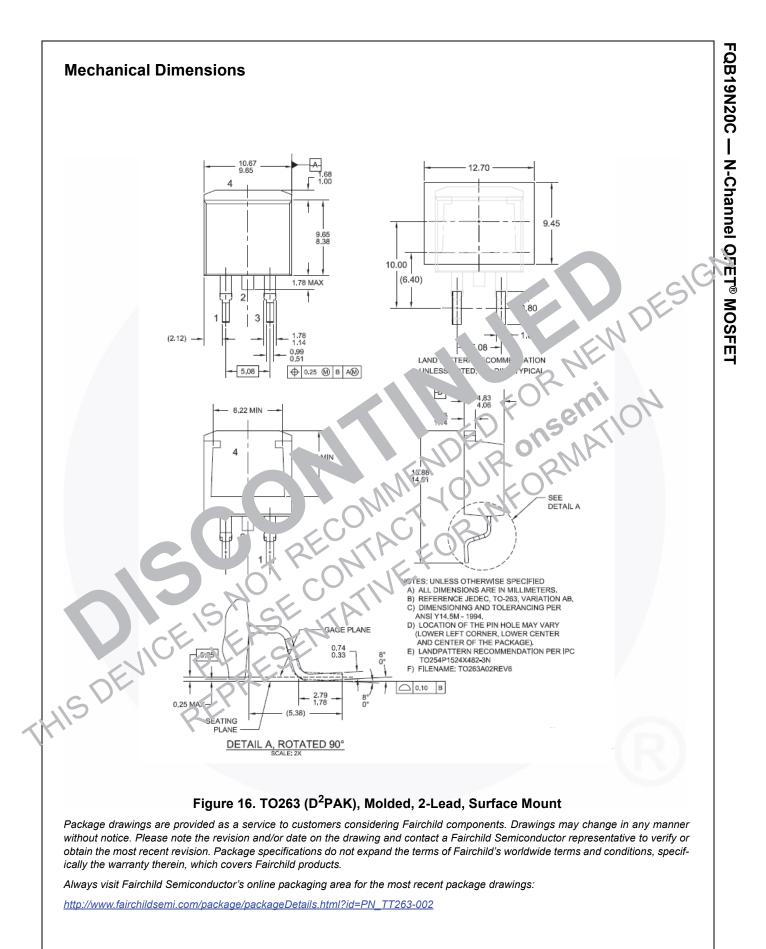
4. Essentially independent of operating temperature.













Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.
		Rev. I66

QB19N20C

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